



100V N-Channel MOSFETs

General Description

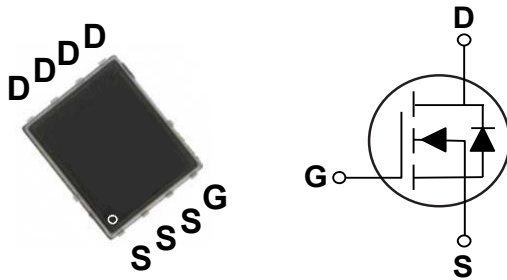
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV_{DSS}	$R_{DS(ON)}$	I_D
100 V	4.2 mΩ	129 A

Features

- $R_{DS(ON)} \leq 4.2m\Omega @ V_{GS}=10V$
- Fast Switching
- Improved dv/dt Capability
- Green Device Available

PPAK5X6 Pin Configuration



Applications

- DC-DC Converter
- Power Management Switches

Absolute Maximum Ratings $T_J=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current - Continuous ($T_C=25^\circ\text{C}$)	129	A
I_{DM}	Drain Current - Pulsed ($T_C=25^\circ\text{C}$) (NOTE 1)	402	A
EAS	Single Pulse Avalanche Energy (NOTE 2)	101.2	mJ
IAS	Single Pulse Avalanche Current (NOTE 2)	45	A
P_D	Power Dissipation ($T_C=25^\circ\text{C}$)	127.5	W
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
Marking Code		NM4P2	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	49	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance Junction to Case	0.98	$^\circ\text{C/W}$



Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	100	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V, V _{GS} =0V	---	---	1	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A	---	---	4.2	mΩ
		V _{GS} =4.5V, I _D =20A	---	---	6	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.4	---	2.4	V
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =20A	---	81	---	S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q _g	Total Gate Charge	V _{DS} =50V, V _{GS} =10V, I _D =20A	---	91	---	nC
Q _{gs}	Gate-Source Charge		---	7.9	---	
Q _{gd}	Gate-Drain Charge		---	31.5	---	
T _{d(on)}	Turn-On Delay Time	V _{DS} =50V, V _{GS} =10V, R _G =10Ω, I _D =20A	---	15.3	---	nS
T _r	Rise Time		---	17.8	---	
T _{d(off)}	Turn-Off Delay Time		---	52.4	---	
T _f	Fall Time		---	23.6	---	
C _{iss}	Input Capacitance	V _{DS} =50V, V _{GS} =0V, F=1MHz	---	3875	---	pF
C _{oss}	Output Capacitance		---	920	---	
C _{rss}	Reverse Transfer Capacitance		---	41	---	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	---	1.2	---	Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =20A	---	---	1.2	V
t _{rr}	Reverse Recovery Time	I _F =20A, V _R =50V,	---	44	---	nS
Q _{rr}	Reverse Recovery Charge	di _F /dt=500A/us	---	212	---	nC

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The EAS data shows Max. rating . The test condition is V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=45A.
3. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
4. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.



Characteristics Curves

FIG. 1 - Output Characteristics

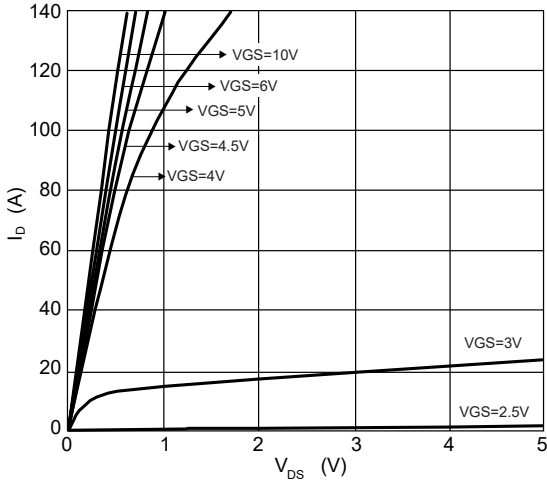


FIG. 2 - Transfer Characteristics

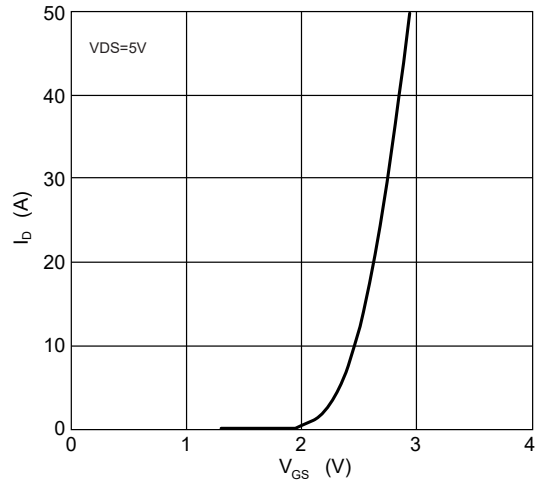


FIG. 3 - I_S vs. V_{SD}

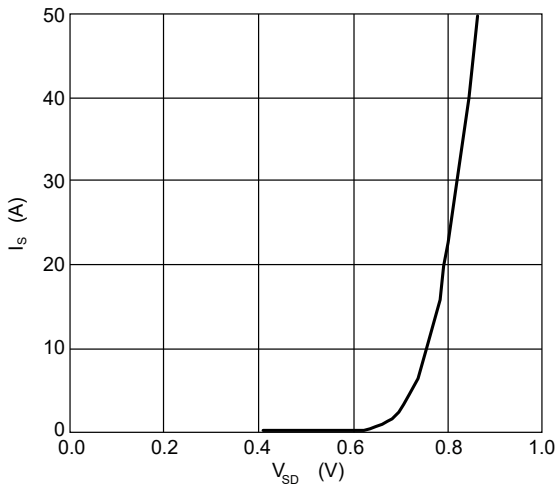


FIG. 4 - Gate Charge Characteristics

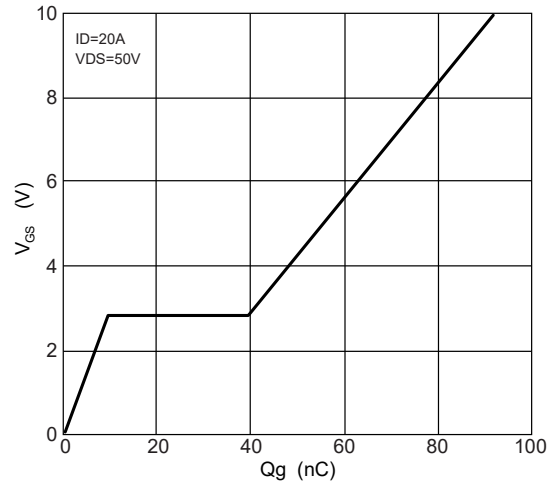


FIG. 5 - $R_{DS(ON)}$ vs. V_{GS}

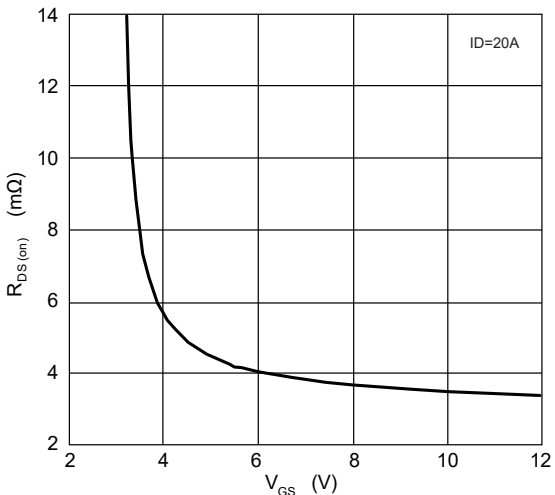
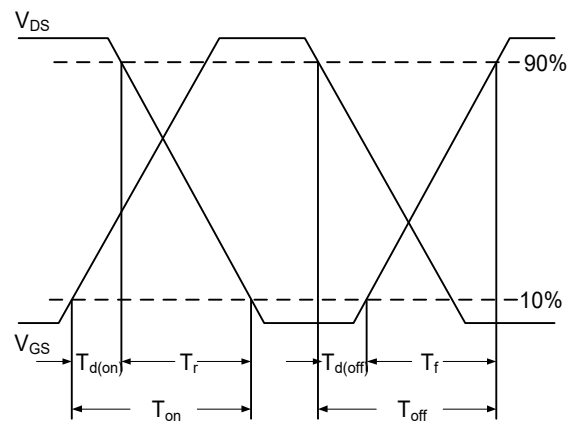


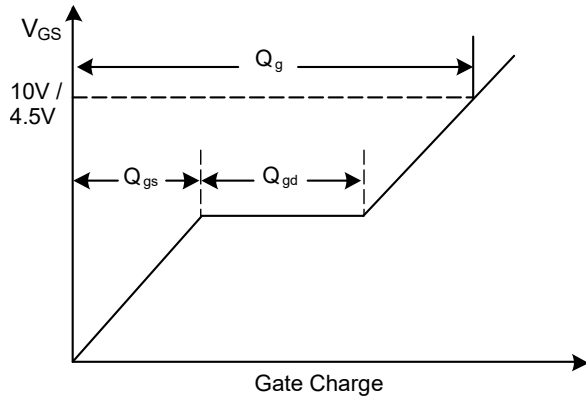
FIG. 6 - Switching Time Waveform



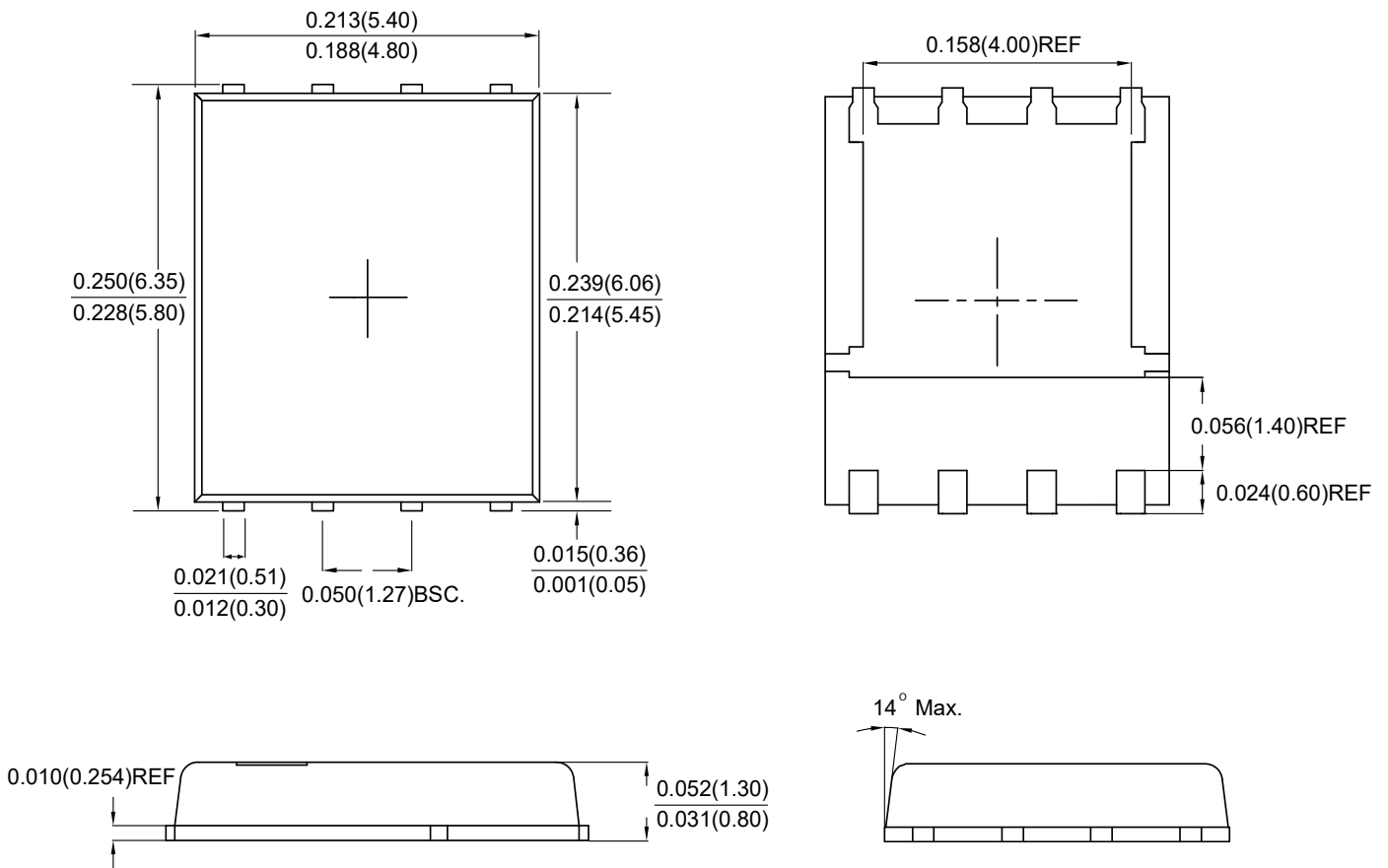


Characteristics Curves

FIG. 7 - Gate Charge Waveform



Package Outline Dimensions



PPAK5X6

Dimensions in inches and (millimeters)



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